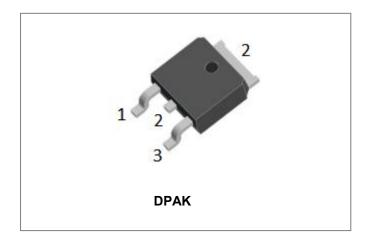






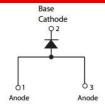
MBRD1060 SCHOTTKY RECTIFIER



Features

- 150℃ T_J operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Terminals finish: 100% Pure Tin
- "-A" is an AEC-Q101 qualified device
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- Disk drives
- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery charging

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	60	V
Average Rectified Forward Current	I _{F (AV)}	50% duty cycle @Tc=105°C, rectangular wave form	10	Α
Peak One Cycle Non-Repetitive Surge Current	I _{FSM}	8.3ms, Half Sine pulse, T _J = 25 °C	120	Α

Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V _{F1}	@ 10A, Pulse, T _J = 25 °C	0.74	0.8	V
	V_{F2}	@ 10A, Pulse, T _J = 125 °C	0.63	0.7	V
Reverse Current *	I _{R1}	$@V_R = \text{rated } V_{R,} T_J = 25 ^{\circ}\text{C}$	0.02	1.0	mA
	I _{R2}	@V _R = rated V _R , T _J = 125 °C	8	30.0	mA
Junction Capacitance	Ст	$@V_R = 5.0V, T_C = 25 °C$ $f_{SIG} = 1MHz$	170	300	pF

^{*} Pulse width < 300 μ s, duty cycle < 2%

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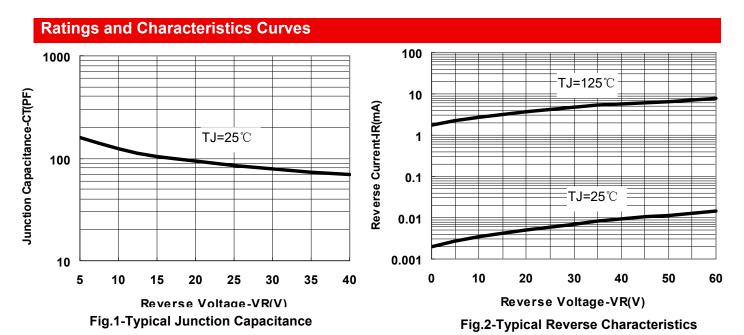






Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T _{stg}	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case	R _θ JC	-	3.5	°C/W
Approximate Weight	wt	-	0.39	g
Case Style	DPAK			



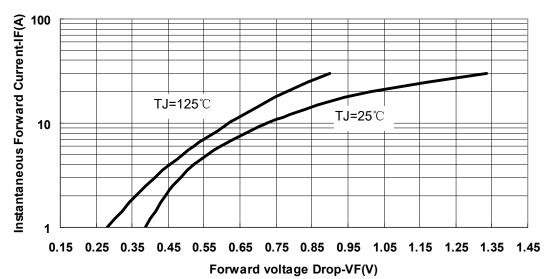


Fig.3-Typical Instantaneous Forward Voltage Characteristics

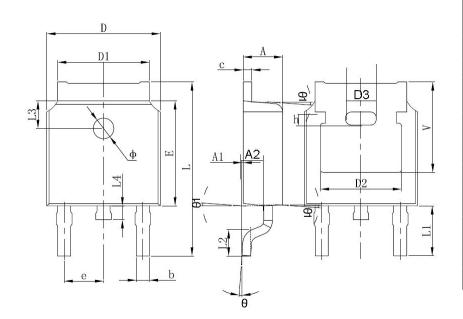
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Mechanical Dimensions DPAK



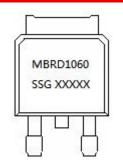
SYMBOL	Dimensions in millimeters			
	Min.	Тур.	Max.	
Α	2.18	-	2.39	
A1	-	-	0.13	
b	0.64	-	0.89	
С	0.46	-	0.89	
D	6.35	-	6.73	
D2	4.32	-	-	
E	5.97	6.10	6.22	
е	2.29BSC			
L	9.40	-	10.41	
L2	1.40	1.52	1.78	
L4	-	-	1.02	
Θ	0°	-	10°	
V	5.21	-	-	

Ordering Information

Device	Package	Shipping
MBRD1060	DPAK (Pb-Free)	2500pcs / reel
MBRD1060TR	DPAK (Pb-Free)	2500pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



Where XXXXX is YYWWL

 MBRD1060
 = Part Name

 SSG
 = SSG

 YY
 = Year

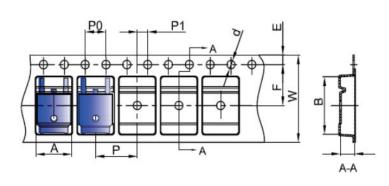
 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

Carrier Tape & Reel Specification DPAK



SYMBOL	Millimeters		
	Min.	Max.	
Α	6.80	7.00	
В	10.40	10.60	
С	2.60	2.80	
d	Ф1.45	Ф1.65	
Е	1.65	1.85	
F	7.40	7.60	
P0	3.90	4.10	
Р	7.90	8.10	
P1	1.90	2.10	
W	15.90	16.30	

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